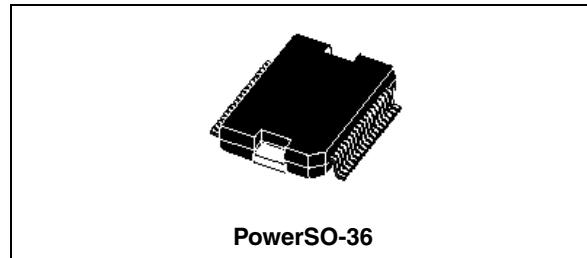


Octal channel high side driver

Features

Type	$R_{DS(on)}$ (1)	I_{out} (1)	V_{CC}
VN808-E	150 mΩ	0.7 A	45 V

1. Per channel
 - $V_{CC}/2$ compatible input
 - Junction overtemperature protection
 - Case overtemperature protection for thermal independence of the channels
 - Current limitation
 - Shorted load protection
 - Undervoltage shut-down
 - Protection against loss of ground
 - Very low stand-by current
 - Compliance to 61000-4-4 IEC test up to 4 kV

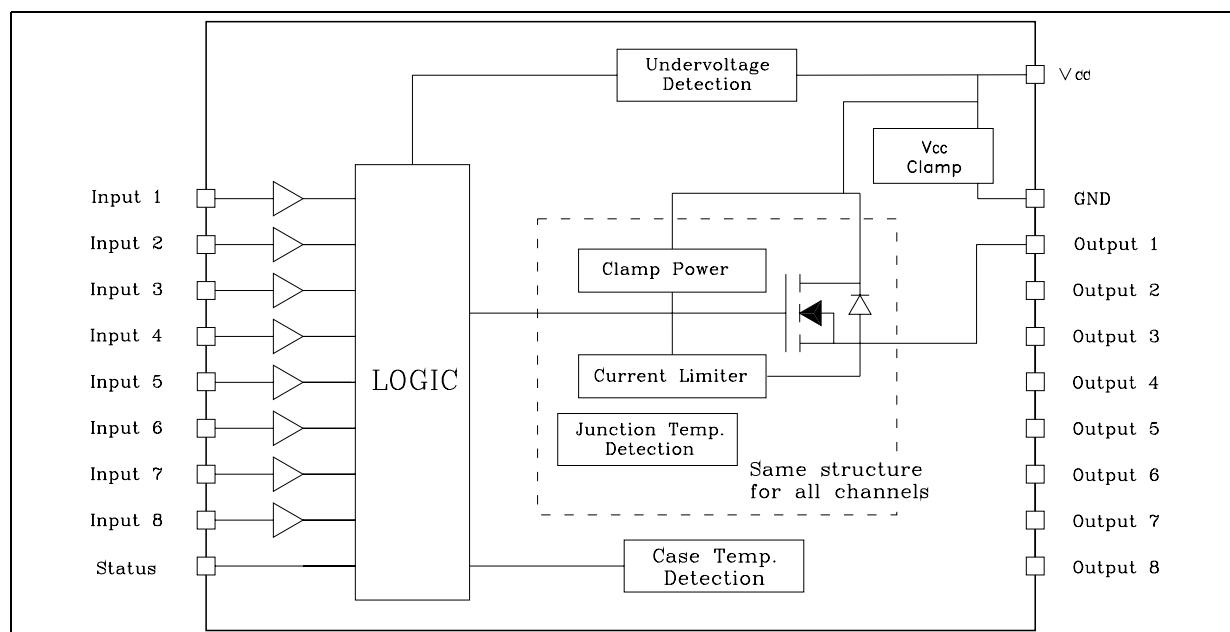


PowerSO-36

Active current limitation combined with thermal shutdown and automatic restart, protect the device against overload. In overload condition, channel turns OFF and back ON automatically so as to maintain junction temperature between T_{TSD} and T_R . If this condition makes case temperature reach T_{CSD} , overloaded channel is turned OFF and will restart only when case temperature has decreased down to T_{CR} (see waveform 3 [Figure 8 on page 11](#)). Non overloaded channels continue to operate normally. Device automatically turns OFF in case of ground pin disconnection. This device is especially suitable for industrial applications conform to IEC 61131

Description

The VN808-E is a monolithic device designed in STMicroelectronics VIPower M0-3 technology, intended for driving any kind of load with one side connected to ground.



Contents

1	Maximum ratings	3
2	Electrical characteristics	4
3	Pin connections	6
4	Current, voltage conventions and internal diagram	8
5	Switching time waveforms	10
6	Reverse polarity protection	13
7	Package mechanical data	14
7.1	Footprint recommended data	16
7.2	Tube shipment information	17
7.3	Tape and reel shipment information	18
8	Order codes	20
9	Revision history	21

1 Maximum ratings

Table 1. Absolute maximum rating

Symbol	Parameter	Value	Unit
V_{CC}	DC supply voltage	45	V
$-I_{GND}$	DC ground pin reverse current TRAN ground pin reverse current (pulse duration < 1ms)	-250 -6	mA A
I_{OUT}	DC output current	Internally limited	A
$-I_{OUT}$	Reverse DC output current	-2	A
I_{IN}	DC input current	± 10	mA
V_{IN}	Input voltage range	-3/+ V_{CC}	V
V_{ESD}	Electrostatic discharge ($R = 1.5 \text{ k}\Omega$; $C = 100 \text{ pF}$)	2000	V
P_{TOT}	Power dissipation at $T_c = 25^\circ\text{C}$	96	W
L_{MAX}	Max inductive load ($V_{CC} = 24 \text{ V}$, $R_{LOAD} = 48 \Omega$, $T_A = 100^\circ\text{C}$)	2	H
T_J	Junction operating temperature	Internally limited	$^\circ\text{C}$
T_C	Case operating temperature	Internally limited	$^\circ\text{C}$
T_{STG}	Storage temperature	-40 to 150	$^\circ\text{C}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case	Max	$^\circ\text{C}/\text{W}$
R_{thJA}	Thermal resistance junction-ambient ⁽¹⁾	Max	$^\circ\text{C}/\text{W}$

1. When mounted on FR4 printed circuit board with 0.5 cm^2 of copper area (at least $35 \mu\text{m}$ thick) connected to all TAB pins.

2 Electrical characteristics

($10.5 \text{ V} < V_{CC} < 32 \text{ V}$; $-40^\circ\text{C} < T_J < 125^\circ\text{C}$; unless otherwise specified)

Table 3. Power section

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V_{CC}	Operating supply voltage		10.5		45	V
V_{USD}	Undervoltage shutdown		7		10.5	V
R_{ON}	On state resistance	$I_{OUT} = 0.5 \text{ A}; T_J = 25^\circ\text{C}$ $I_{OUT} = 0.5 \text{ A};$		150 280	185 mΩ	mΩ
I_S	Supply current	OFF state; $V_{CC} = 24 \text{ V}$; $T_{CASE} = 25^\circ\text{C}$ ON state (all channels ON); $V_{CC} = 24 \text{ V}, T_{CASE} = 100^\circ\text{C}$			150 12	μA mA
I_{LGND}	Output current at turn-off	$V_{CC} = V_{STAT} = V_{IN} = V_{GND} = 24 \text{ V}$ $V_{OUT} = 0 \text{ V}$			1	mA
$I_{L(off)}$	OFF state output current	$V_{IN} = V_{OUT} = 0 \text{ V};$	0		5	μA
$V_{OUT(off)}$	OFF state output voltage	$V_{IN} = 0 \text{ V}, I_{OUT} = 0 \text{ A}$			3	V
$t_{d(V_{CCON})}$	Power-on delay time from V_{CC} rising edge	Figure 7 on page 10		1		ms

Table 4. Switching ($V_{CC} = 24 \text{ V}$)

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
t_{ON}	Turn-on time	$R_L = 48 \Omega$ from 80% V_{OUT} Figure 6.		50	100	μs
t_{OFF}	Turn-off time	$R_L = 48 \Omega$ to 10% V_{OUT} Figure 6.		75	150	μs
$dV_{OUT}/dt_{(on)}$	Turn-on voltage slope	$R_L = 48 \Omega$ from $V_{OUT} = 2.4 \text{ V}$ to $V_{OUT} = 19.2 \text{ V}$ Figure 6.		0.7		V/μs
$dV_{OUT}/dt_{(off)}$	Turn-off voltage slope	$R_L = 48 \Omega$ from $V_{OUT} = 21.6 \text{ V}$ to $V_{OUT} = 2.4 \text{ V}$ Figure 6.		1.5		V/μs

Table 5. Input pin

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V_{INL}	Input low level				$V_{CC}/2-1$	V
I_{INL}	Low level input current	$V_{IN} = V_{CC}/2 - 1\text{ V}$	80			μA
V_{INH}	Input high level		$V_{CC}/2+1$			V
I_{INH}	High level input current	$V_{IN} = V_{CC}/2 + 1\text{ V}$		150	260	μA
$V_{I(HYST)}$	Input hysteresis voltage			0.6		V
I_{IN}	Input current	$V_{IN} = V_{CC} = 32\text{ V}$			300	μA

Table 6. Protections

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
T_{CSD}	Case shut-down temperature		125	130	135	°C
T_{CR}	Case reset temperature		110			°C
T_{CHYST}	Case thermal hysteresis		7	15		°C
T_{TSD}	Junction shutdown temperature		150	175	200	°C
T_R	Junction reset temperature		135			°C
T_{HYST}	Junction thermal hysteresis		7	15		°C
I_{lim}	DC short circuit current per channel	$V_{CC} = 24\text{ V}; R_{LOAD} = 10\text{ m}\Omega$	0.7		1.7	A
V_{demag}	Turn-off output clamp voltage	$I_{OUT} = 0.5\text{ A}; L = 6\text{ mH}$	$V_{CC}-57$	$V_{CC}-52$	$V_{CC}-47$	V

Table 7. Status pin

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
I_{HSTAT}	High level output current	$V_{CC} = 18\dots32\text{ V}; R_{STAT} = 1\text{ k}\Omega$ (Fault condition)	2	3	4	mA
I_{LSTAT}	Leakage current	Normal operation; $V_{CC} = 32\text{ V}$			0.1	μA
V_{CLSTAT}	Clamp voltage	$I_{STAT} = 1\text{ mA}$ $I_{STAT} = -1\text{ mA}$	6.0	6.8 -0.7	8.0	V V

3 Pin connections

Figure 2. Connection diagram (top view)

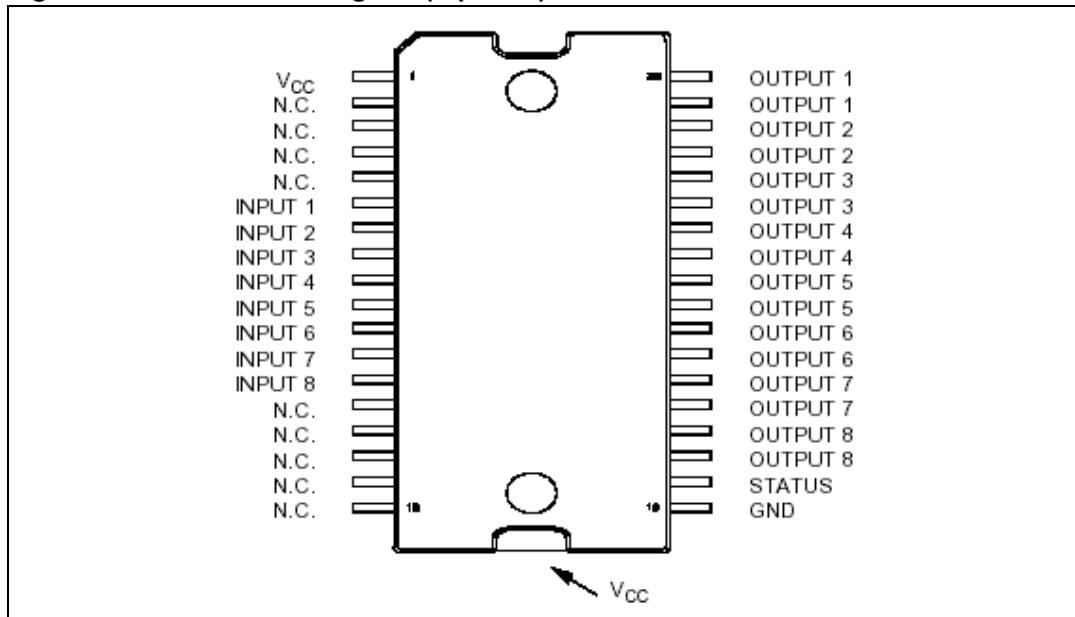


Table 8. Pin functions

Pin N°	Symbol	Function
TAB	V _{CC}	Positive power supply voltage
1	V _{CC}	Positive power supply voltage
2,3,4,5	NC	Not connected
6	Input 1	Input of channel 1
7	Input 2	Input of channel 2
8	Input 3	Input of channel 3
9	Input 4	Input of channel 4
10	Input 5	Input of channel 5
11	Input 6	Input of channel 6
12	Input 7	Input of channel 7
13	Input 8	Input of channel 8
14,15,16,17,18	NC	Not connected
19	GND	Logic ground
20	STATUS	Common open source diagnostic for overtemperature
21,22	Output 8	High-side output of channel 8
23,24	Output 7	High-side output of channel 7
25, 26	Output 6	High-side output of channel 6

Table 8. Pin functions (continued)

Pin N°	Symbol	Function
27, 28	Output 5	High-side output of channel 5
29, 30	Output 4	High-side output of channel 4
31, 32	Output 3	High-side output of channel 3
33, 34	Output 2	High-side output of channel 2
35, 36	Output 1	High-side output of channel 1

4 Current, voltage conventions and internal diagram

Figure 3. Current and voltage conventions

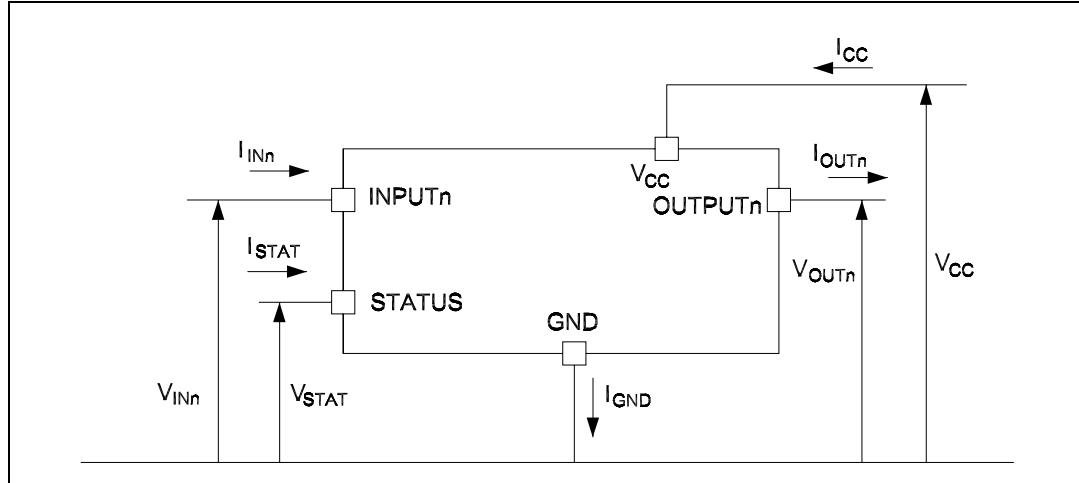


Figure 4. Equivalent internal block diagram (same structure for all channel)

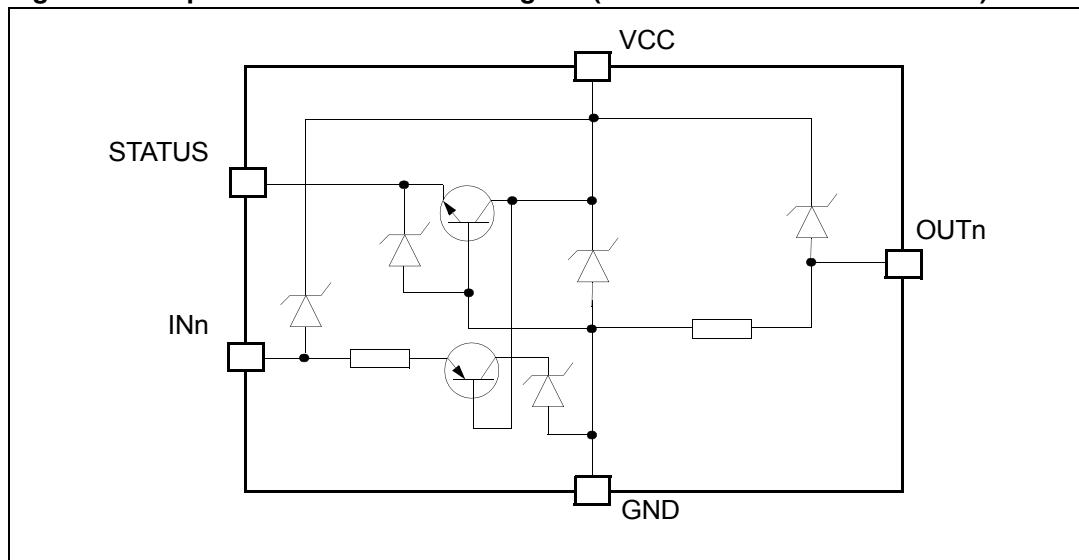


Figure 5. Application example

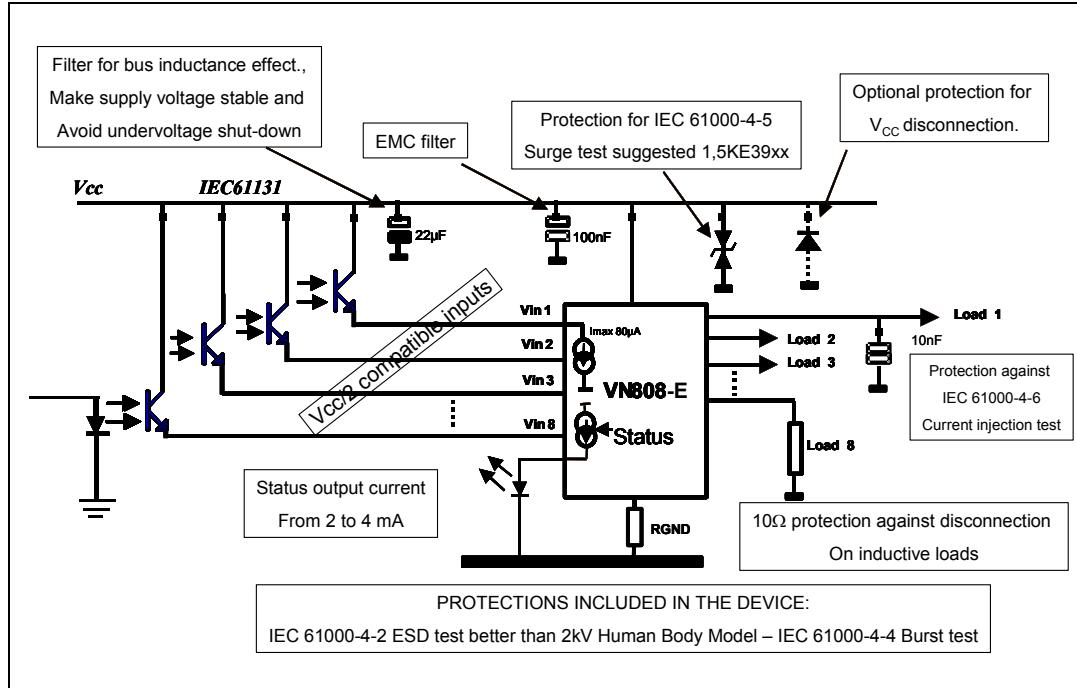


Table 9. Truth table

Conditions	INPUTn	OUTPUTn	STATUS
Normal operation	L H	L H	L L
Current limitation	L H	L X	L L
Overtemperature (see waveforms 3, 4 <i>Figure 8</i>) $\rightarrow T_J > T_{TSD}$	L H	L L	L H
Undervoltage	L H	L L	X X

5 Switching time waveforms

Figure 6. Turn-ON and turn-OFF

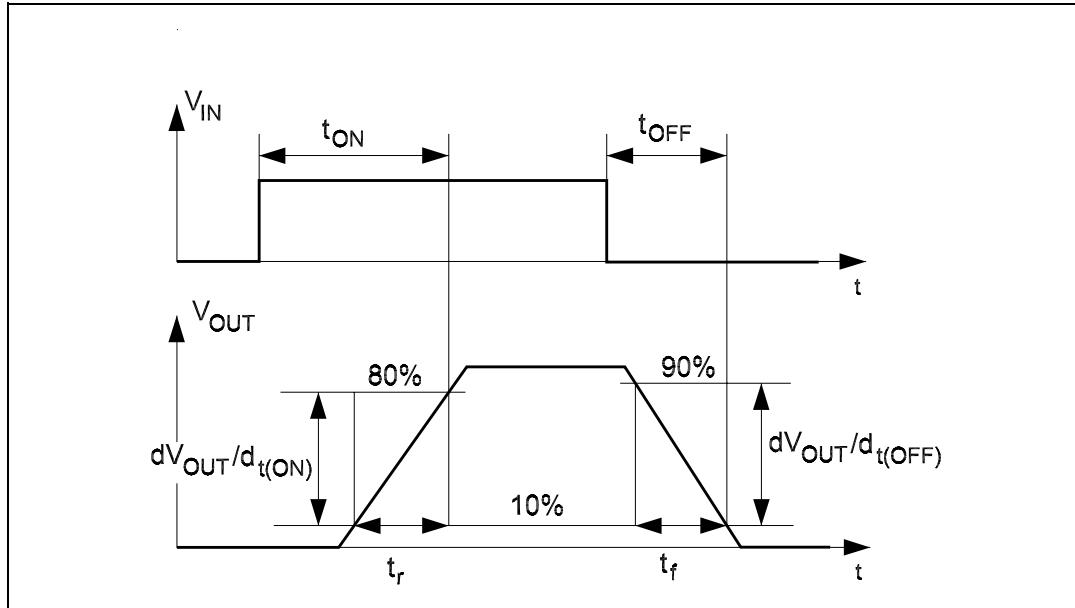


Figure 7. V_{CC} turn-ON

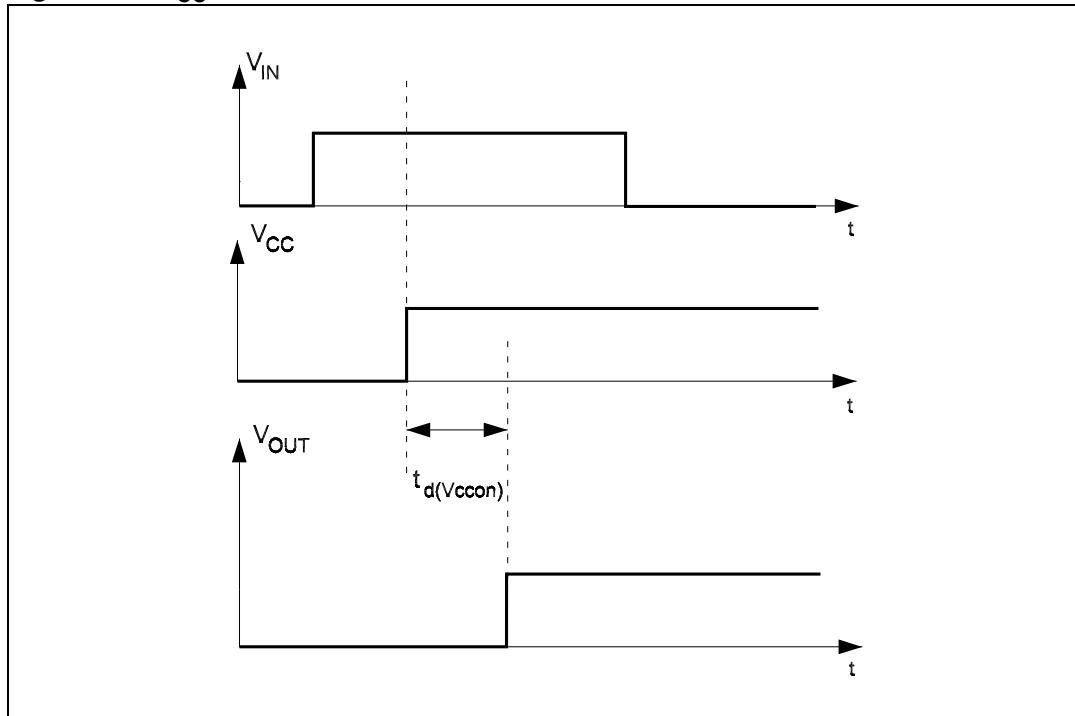


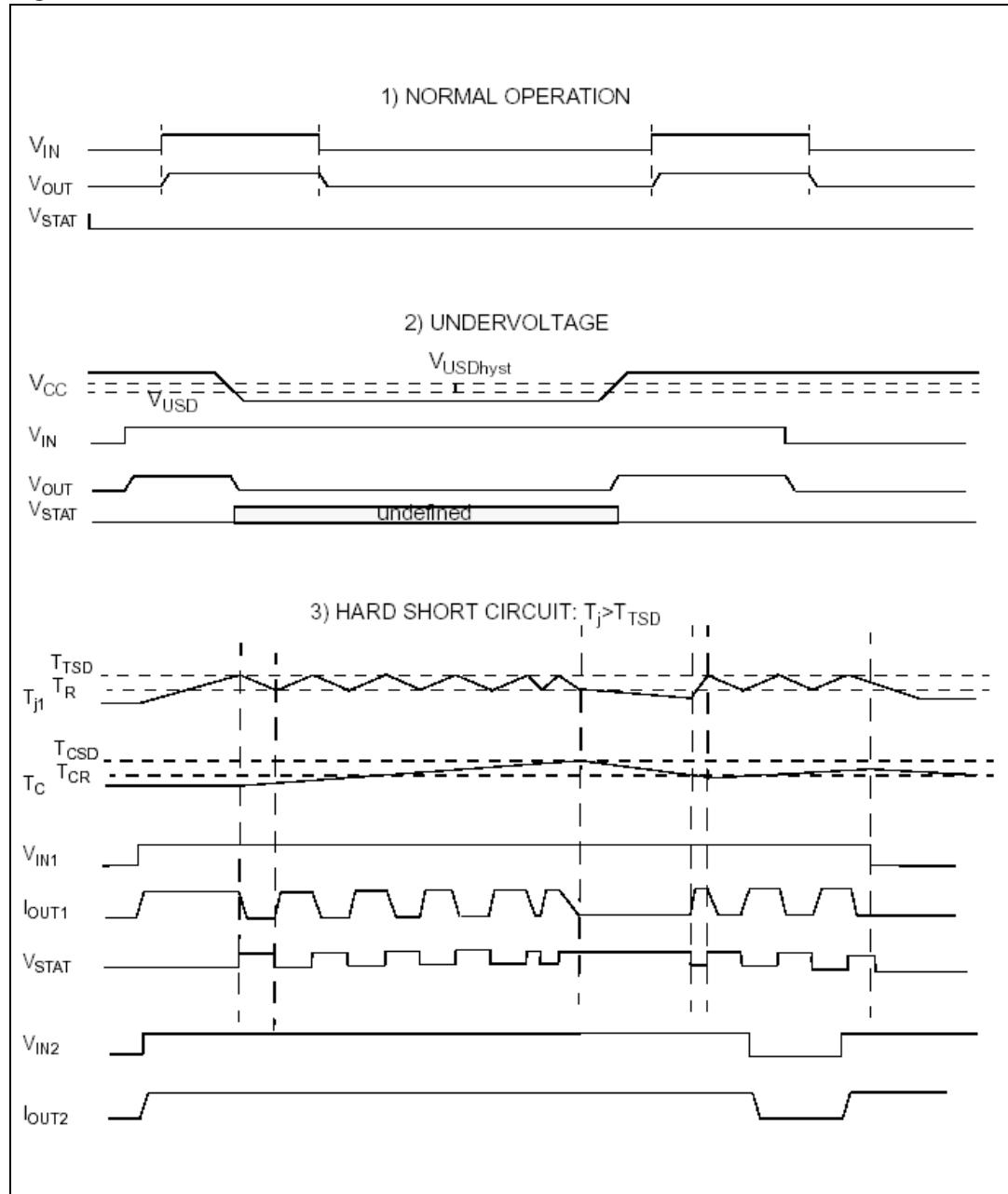
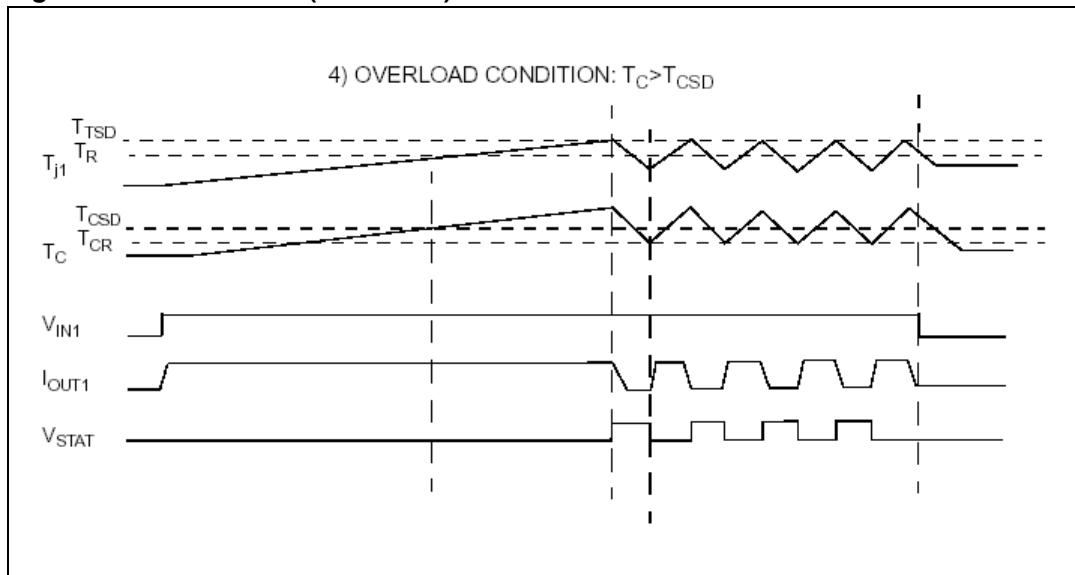
Figure 8. Waveforms

Figure 8. Waveforms (continued)

6 Reverse polarity protection

This schematic can be used with any type of load.

The following is an indication on how to dimension the R_{GND} resistor.

$$R_{GND} = (-V_{CC}) / (-I_{GND})$$

where $-I_{GND}$ is the DC reverse ground pin current and can be found in the absolute maximum rating section of the device datasheet.

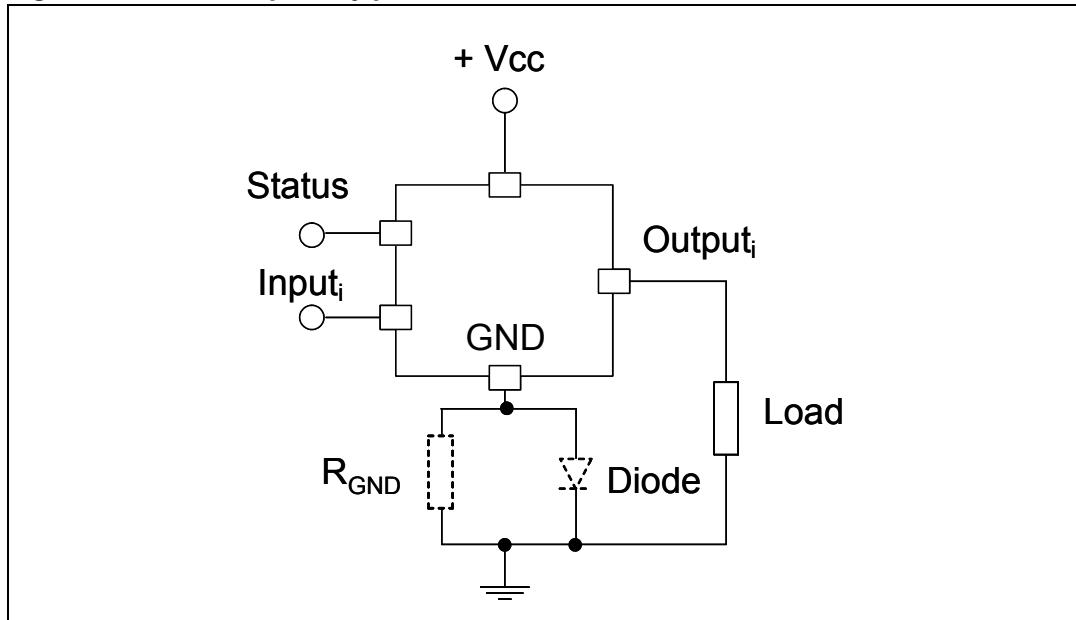
Power dissipation in R_{GND} (when $V_{CC} < 0$: during reverse polarity situations) is:

$$PD = (-V_{CC})^2 / R_{GND}$$

Note:

In normal condition (no reverse polarity) due to the diode there will be a voltage drop between GND of the device and GND of the system.

Figure 9. Reverse polarity protection

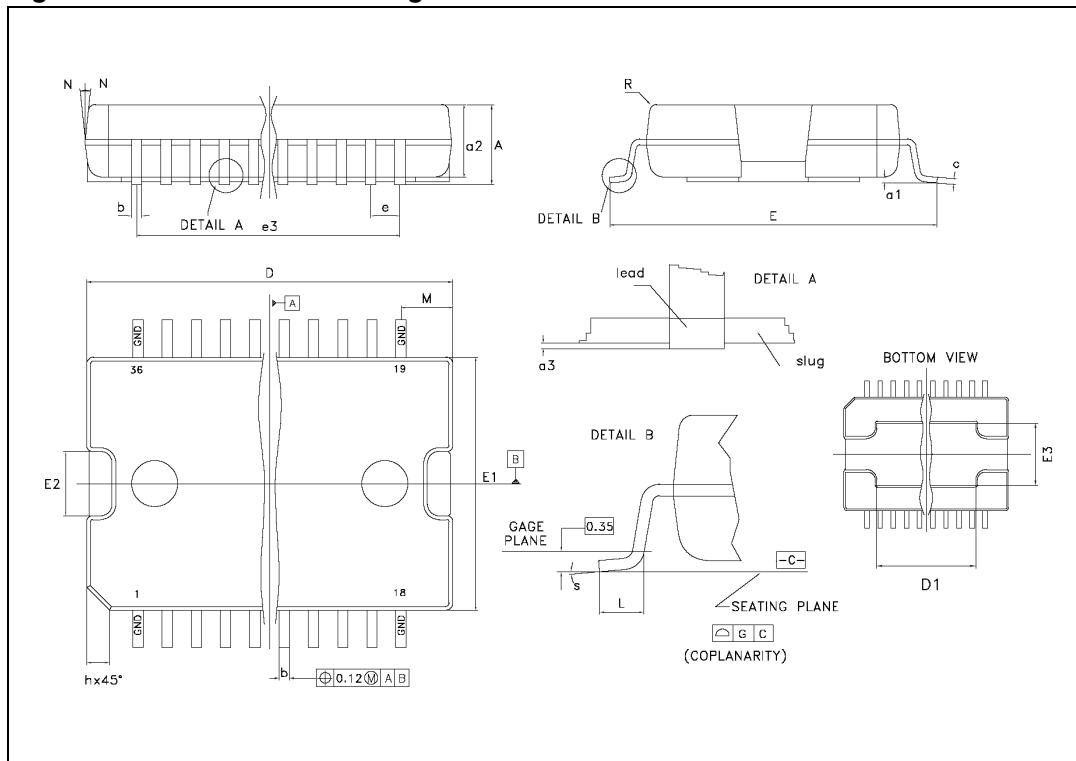


7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
ECOPACK is an ST trademark.

Table 10. PowerSO-36 mechanical data

Dim.	mm			inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			3.60			0.1417
a1	0.10		0.30	0.003		0.0118
a2			3.30			0.1299
a3	0		0.10	0		0.0039
b	0.22		0.38	0.008		0.0150
c	0.23		0.32	0.009		0.0126
D (1)	15.80		16.00	0.622		0.6299
D1	9.40		9.80	0.370		0.3858
E	13.90		14.50	0.547		0.5709
E1 (1)	10.90		11.10	0.429		0.4370
E2			2.90			0.1142
E3	5.8		6.2	0.228		0.2441
e		0.65			0.025	
e3		11.05			0.435	
G	0		0.10	0.000		0.0039
H	15.50		15.90	0.610		0.6260
h			1.10			0.0433
L	0.80		1.10	0.031		0.0433
N			10°			10°
S	0°		8°	0°		8°

Figure 10. PowerSO-36 drawings

7.1 Footprint recommended data

Figure 11. Footprint recommended data

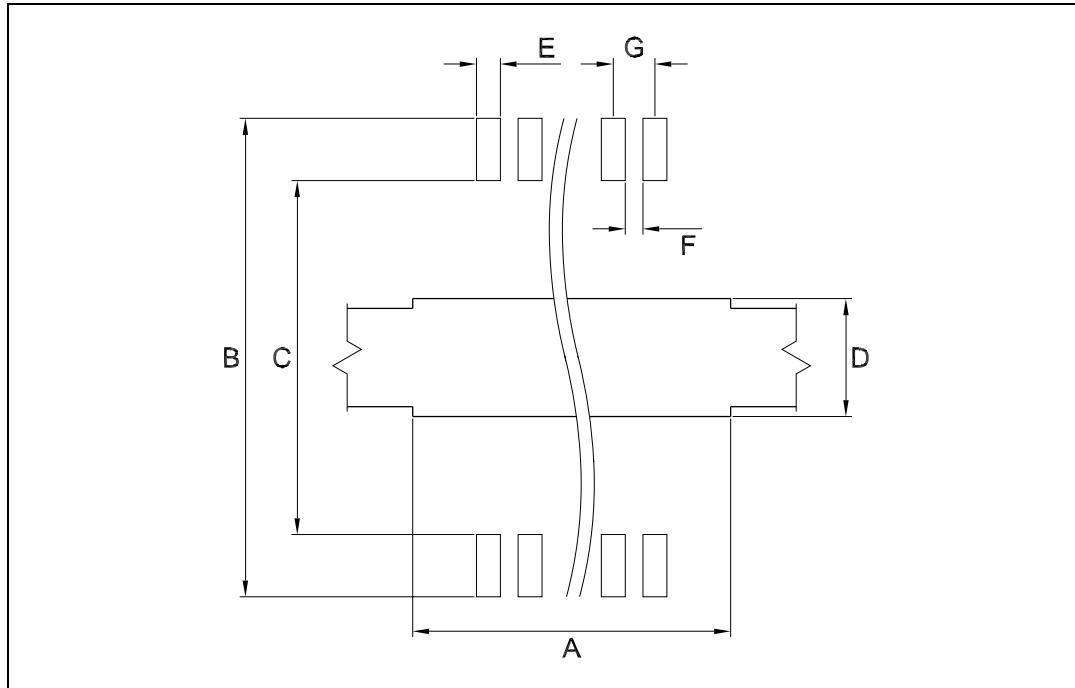


Table 11. Footprint data

Dim.	mm.	inch
A	9.5	0.374
B	14.7-15.0	0.579-0.591
C	12.5-12.7	0.492-0.500
D	6.3	0.248
E	0.46	0.018
F	0.27	0.011
G	0.65	0.026

7.2 Tube shipment information

Figure 12. Tube shipment information

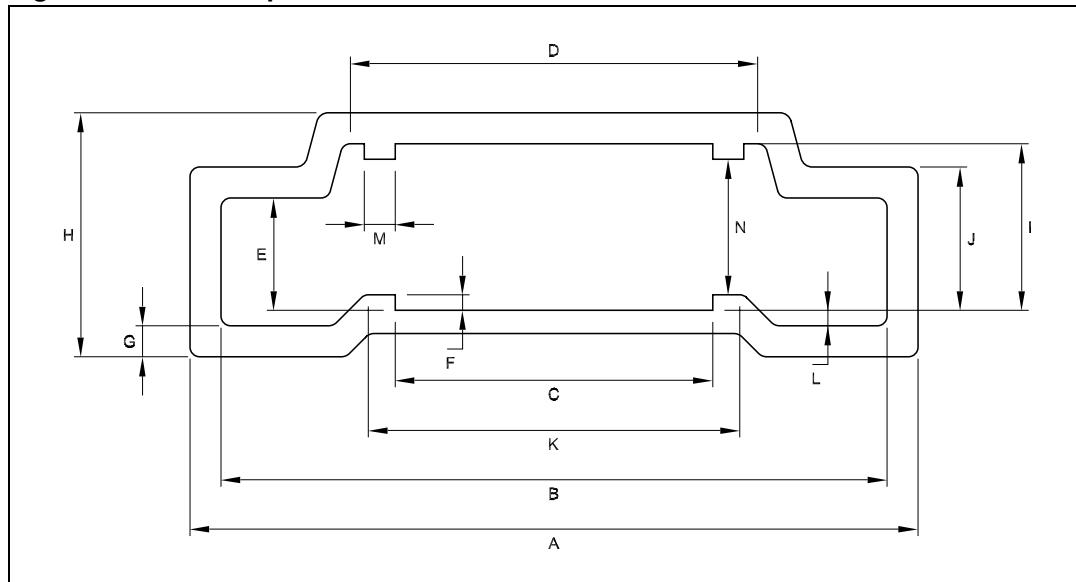


Table 12. Tube mechanical data

Dim.	mm.	inch
A	18.80	0.740
B	17.2 ± 0.2	0.677 ± 0.008
C	8.20 ± 0.2	0.323 ± 0.008
D	10.90 ± 0.2	0.429 ± 0.008
E	2.90 ± 0.2	0.114 ± 0.008
F	0.40	0.016
G	0.80	0.031
H	6.30	0.248
I	4.30 ± 0.2	0.165 ± 0.008
J	3.7 ± 0.2	0.146 ± 0.008
K	9.4	0.370
L	0.40	0.016
M	0.80	0.031
N	3.50 ± 0.2	0.138 ± 0.008

Base quantity 31 pcs.

Bulk quantity 310 pcs.

7.3 Tape and reel shipment information

Figure 13. Tape specifications

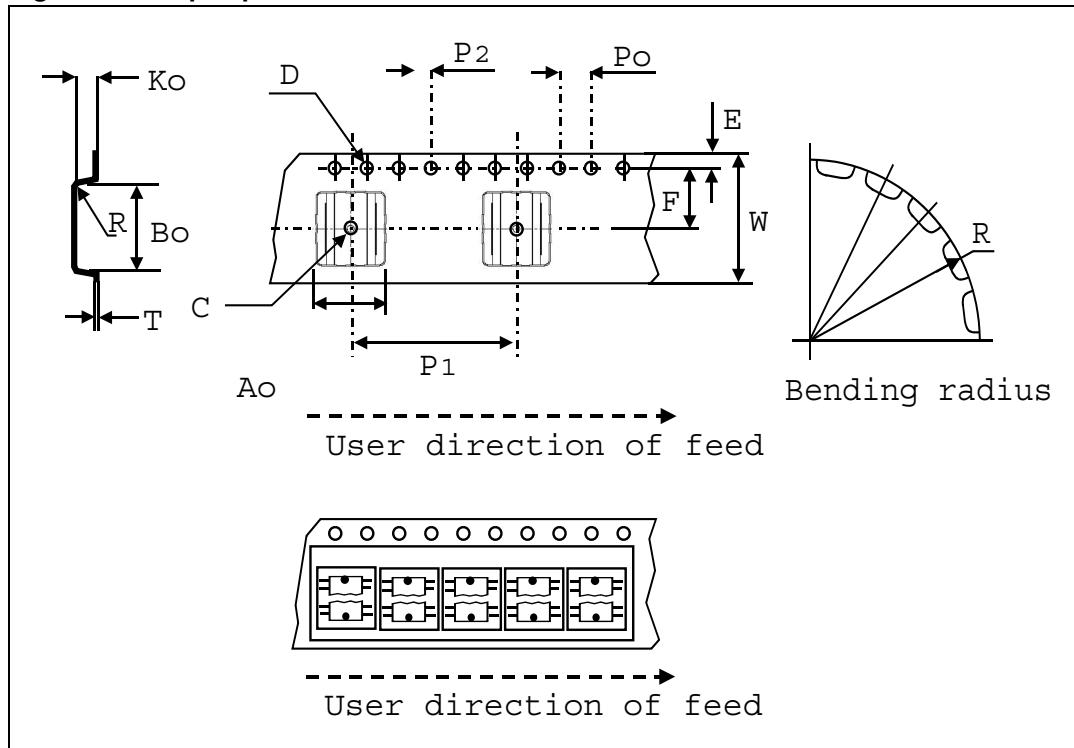
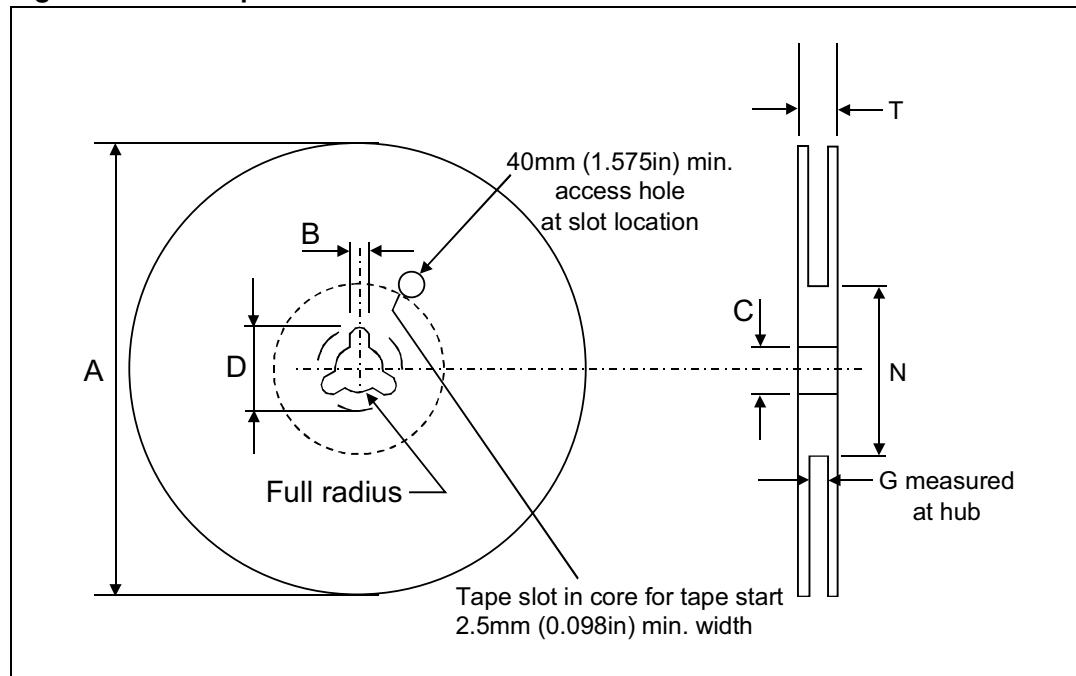


Table 13. Tape mechanical data

Dim.	mm.	inch
D	1.50 +0.1/0	0.059 +0.004/0
E	1.75 ±0.1	0.069 ±0.004
P _O	4.00 ±0.1	0.157 ±0.004
T max.	0.40	0.016
D ₁ min.	1.50	0.059
F	11.5 ±0.05	0.453 ±0.002
K max.	6.50	0.256
P ₂	2.00 ±0.1	0.079 ±0.004
R	50	1.968
W	24.00 ±0.30	0.945 ±0.012
P ₁	24.00	0.945
A _O , B _O , K _O	0.05 min to 1.0 max.	0.002 min to 0.039 max.

Base quantity 600 pcs.

Bulk quantity 600 pcs.

Figure 14. Reel specifications**Table 14. Reel mechanical data**

Dim.	mm.	inch
Tape size	24.0 ± 0.30	0.945 ± 0.012
A max.	330.0	12.992
B min.	1.5	0.059
C	13.0 ± 0.20	0.512 ± 0.008
D min.	20.2	0.795
N min.	60	2.362
G	$24.4 +2/-0$	$0.960 +0.079/-0$
T max.	30.4	1.197

8 Order codes

Table 15. Order codes

Order codes	Package	Packaging
VN808-E	PowerSO-36	Tube
VN808TR-E	PowerSO-36	Tape and reel

9 Revision history

Table 16. Document revision history

Date	Revision	Changes
13-Sep-2005	1	Initial release
1-Mar-2007	2	Document reformatted
12-Mar-2007	3	Typo in <i>Figure 3</i> .
26-Mar-2007	4	Typo note <i>Table 2</i> .
07-Jul-2008	5	Added: <i>Section 6 on page 13</i>
04-Aug-2008	6	Added: <i>Figure 11: PowerSO-36 footprint on page 15</i>
25-Aug-2009	7	Updated <i>Section 6: Reverse polarity protection</i>
24-Feb-2010	8	Updated <i>Section 7: Package mechanical data</i>

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com